



DMTH10H015LPS

100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI

Product Summary

BV _{DSS}	R _{DS(ON)} Max	Ι _D T _C = +25°C
100V -	16mΩ @ V _{GS} = 10V	44A
	18mΩ @ V _{GS} = 6V	41A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and load switch.

Applications

- Motor Control
- DC-DC Converters
- Power Management

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Weight: 0.097 grams (Approximate)

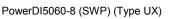
Top View



Bottom View

Site 2:

Site 1:

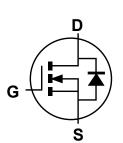


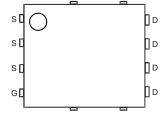
PowerDI5060-8



Top View

Bottom View

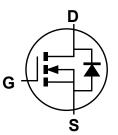




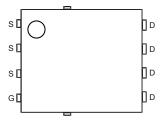
Top View

Pin Configuration

Internal Schematic



Internal Schematic



Top View Pin Configuration

PowerDI is a registered trademark of Diodes Incorporated. DMTH10H015LPS Document number: DS38713 Rev. 3 - 2 Pin1

Pin1



Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H015LPS-13	PowerDI5060-8	2,500/Tape & Reel

Notes:

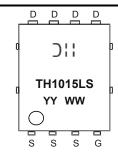
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



);; = Manufacturer's Marking
TH1015LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Digit of Year (ex: 20 = 2020)
WW = Week Code (01 to 53)

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	100	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Durin Current (Note 5).)/ - 10)/	Steady State	T _A = +25°C T _A = +70°C	ID	11 8	А
Continuous Drain Current (Note 5) V_{GS} = 10V	Steady State	T _C = +25°C T _C = +100°C	ID	44 28	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	120	А	
Maximum Continuous Body Diode Forward Current (Note 5)			ls	1.5	А
Avalanche Current (Note 7) L=3mH			I _{AS}	7.5	А
Avalanche Energy (Note 7) L=3mH			Eas	85	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)		R _{0JA}	52	°C/W
Total Power Dissipation	T _C = +25°C	PD	46	W
Thermal Resistance, Junction to Case		R _{eJC}	2.7	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C



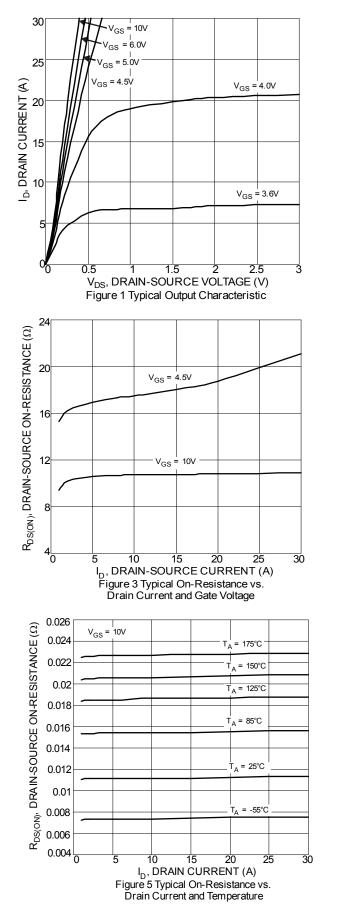
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

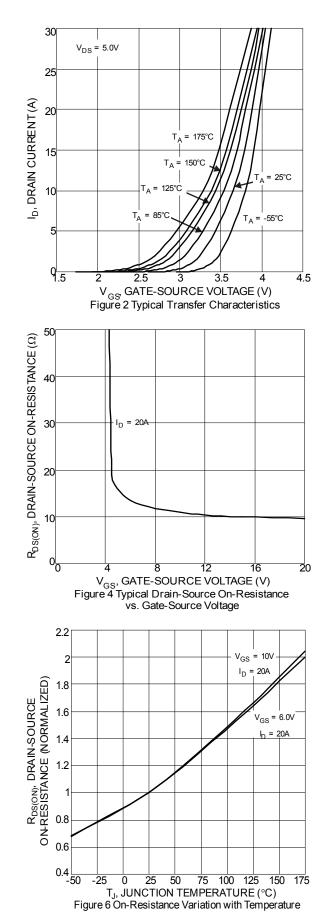
b	-			-	-	-
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	100	—	—	V	V_{GS} = 0V, I_D = 1mA
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(TH)}	1.4	2	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		_	11	16		V _{GS} = 10V, I _D = 20A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	13.5	18	mΩ	V _{GS} = 6V, I _D = 20A
	. ,	_	18.4	25		V _{GS} = 4.5V, I _D = 5A
Diode Forward Voltage	V _{SD}	_	0.9	1.3	V	V _{GS} = 0V, I _S = 20A
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	CISS	_	1,871	_	pF	V _{DS} = 50V, V _{GS} = 0V f = 1MHz
Output Capacitance	C _{OSS}		261	_		
Reverse Transfer Capacitance	C _{RSS}		7	_		
Gate Resistance	R _G	_	0.75	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge	Q _G	_	33.3	_		
Gate-Source Charge	Q _{GS}	_	6.9	_	nC	V _{DD} = 50V, I _D = 10A, V _{GS} = 10V
Gate-Drain Charge	Q _{GD}	_	5.1	_		
Turn-On Delay Time	t _{D(ON)}	_	6.5	_		
Turn-On Rise Time	t _R	_	7	_	ns	V_{DD} = 50V, V_{GS} = 10V, I _D = 10A, R_G = 6 Ω
Turn-Off Delay Time	t _{D(OFF)}	_	19.7	_		
Turn-Off Fall Time	tF		8.1	_]	
Reverse Recovery Time	t _{RR}	_	37.9	_	ns	
Reverse Recovery Charge	Q _{RR}		51.9	_	nC	-I _F = 10A, di/dt = 100A/μs

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:

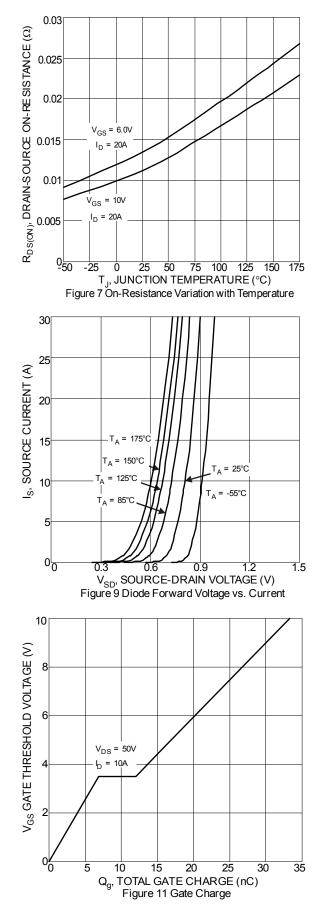


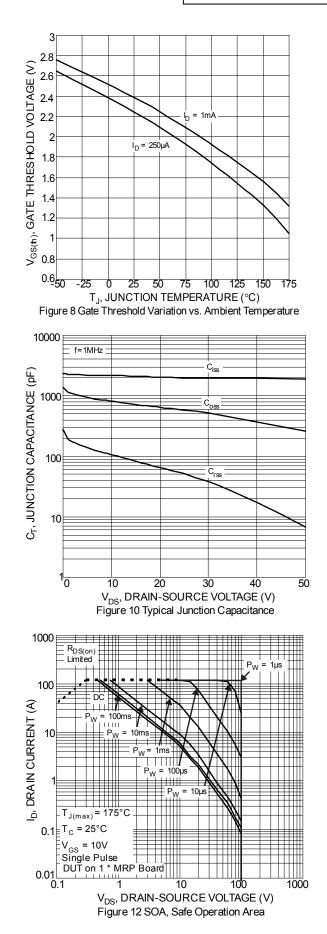
DMTH10H015LPS



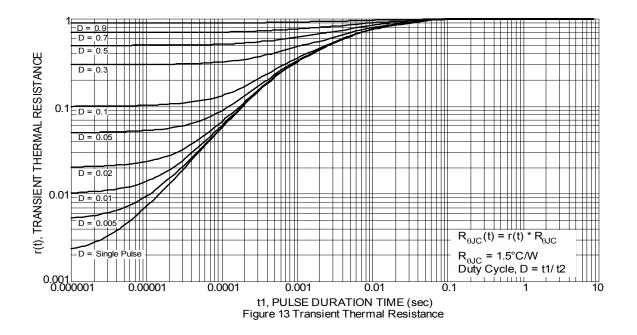










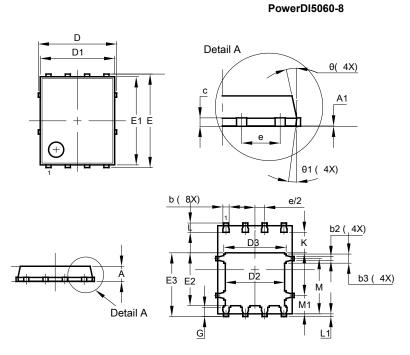




Package Outline Dimensions

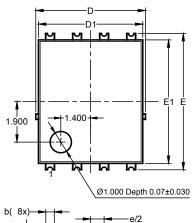
Please see http://www.diodes.com/package-outlines.html for the latest version.

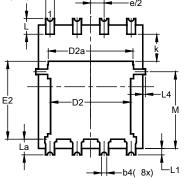
Site 1:



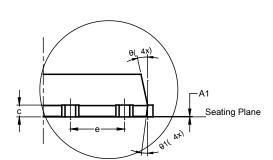
	PowerDI5060-8					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05	-			
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
С	0.230	0.330	0.277			
D		5.15 BSC				
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90	4.30	4.10			
ш	6.15 BSC					
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е		1.27 BSC				
G	0.51	0.71	0.61			
ĸ	0.51	-	-			
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
М	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
Θ	10°	12°	11°			
Θ1	6°	8°	7°			
All Dimensions in mm						

Site 2:

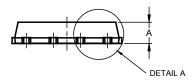




PowerDI5060-8 (SWP) (Type UX)



DETAIL A



PowerDI5060-8 (SWP) (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	0	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
ш	6	.40 BSC	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595		
е	1	I.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	-	.050RE		
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All	Dimensi	ions in	mm	

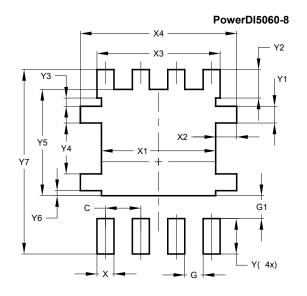
DMTH10H015LPS Document number: DS38713 Rev. 3 - 2



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

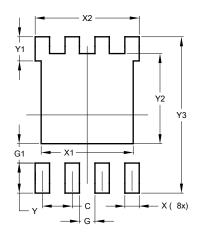
Site 1:



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
Х	0.610	
X1	4.100	
X2	4.420	
Y	1.270	
Y1	1.020	
Y2	3.810	
Y3	6.610	



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